

# **Dual N-Channel 20 V (D-S) MOSFET**

# PowerPAK® SC-70-6L Dual

**Bottom View** 

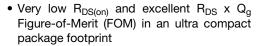
#### Marking code: A7

Top View

PRODUCT SUMMARY									
V <sub>DS</sub> (V)	20								
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10 \text{ V}$	0.0215								
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 4.5 \text{ V}$	0.0245								
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 2.5 \text{ V}$	0.048								
Q <sub>g</sub> typ. (nC)	3.5								
I <sub>D</sub> (A) <sup>a</sup>	4.5								
Configuration	Dual								

#### **FEATURES**

TrenchFET® Gen IV power MOSFET

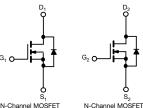




- · Compact and thermally enhanced package
- · Provides exceptional versatility for power management
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### **APPLICATIONS**

- · Synchronous rectification
- Half-bridge power stage
- DC/DC converters
- · Battery management
- Load switch



D <sub>2</sub>
$G_2$ $G_2$ $G_2$ $G_2$ $G_3$ $G_4$ $G_5$ $G_5$ $G_5$
3 <sub>2</sub>

ORDERING INFORMATION	
Package	PowerPAK SC-70
Lead (Pb)-free and halogen-free	SiA938DJT-T1-GE3

ABSOLUTE MAXIMUM RATING	<b>S</b> (T <sub>A</sub> = 25 °C, u	nless other	wise noted)	
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		$V_{DS}$	20	V
Gate-source voltage		$V_{GS}$	+12 / -8	7 v
	T <sub>C</sub> = 25 °C		4.5 <sup>a</sup>	
Oti	T <sub>C</sub> = 70 °C	1 .	4.5 <sup>a</sup>	1
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	l <sub>D</sub>	4.5 <sup>a, b, c</sup>	1
	T <sub>A</sub> = 70 °C	†	4.5 <sup>a, b, c</sup>	Α
Pulsed drain current	•	I <sub>DM</sub>	30	
	T <sub>C</sub> = 25 °C		4.5 <sup>a</sup>	
Continuous source-drain diode current	T <sub>A</sub> = 25 °C	l <sub>S</sub>	1.6 <sup>b, c</sup>	1
	T <sub>C</sub> = 25 °C		7.8	
Maximum power dissipation	T <sub>C</sub> = 70 °C	P <sub>D</sub>	5	$\Box$ w
Maximum power dissipation	T <sub>A</sub> = 25 °C	FD FD	1.9 b, c	
	T <sub>A</sub> = 70 °C		1.2 <sup>b, c</sup>	
Operating junction and storage temperature	e range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Soldering recommendations (peak tempera	ture) <sup>d, e</sup>		260	

THERMAL RESISTANCE RATINGS									
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT				
Maximum junction-to-ambient b, f	t ≤ 5 s	$R_{thJA}$	52	65	°C/W				
Maximum junction-to-case (drain)	Steady state	$R_{thJC}$	12.5	16	- C/W				

#### Notes

- a. Package limited
- b. Surface mounted on 1" x 1" FR4 board
- See solder profile (www.vishay.com/doc?73257). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- Rework conditions: manual soldering with a soldering iron is not recommended for leadless components
- Maximum under steady state conditions is 110 °C/W

# Vishay Siliconix

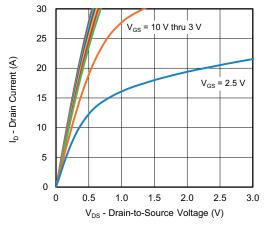
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static			1	1		
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	20	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	L 050 A	-	13	-	mV/°C
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	-	-3.3	-	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$	0.6	-	1.5	V
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = +12 \text{ V} / -8 \text{ V}$	-	-	± 100	nA
Zono del college del consel		$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	μА
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C	-	-	10	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	5	-	-	Α
		$V_{GS} = 10 \text{ V}, I_D = 5 \text{ A}$	-	0.0170	0.0215	
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 5 \text{ A}$	-	0.0190	0.0245	Ω
		$V_{GS} = 2.5 \text{ V}, I_D = 3 \text{ A}$	-	0.0300	0.0480	
Forward transconductance a	9 <sub>fs</sub>	$V_{DS} = 10 \text{ V}, I_D = 10 \text{ A}$	-	28	-	S
Dynamic <sup>b</sup>						
Input capacitance	C <sub>iss</sub>		-	425	-	рF
Output capacitance	C <sub>oss</sub>	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	150	-	
Reverse transfer capacitance	C <sub>rss</sub>		-	30	-	
Total gate aboves	Q <sub>g</sub>	$V_{DS} = 10 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 5 \text{ A}$	-	7.6	11.5	nC
Total gate charge			-	3.5	5.3	
Gate-source charge	Q <sub>gs</sub>	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 5 \text{ A}$		1.2	-	
Gate-drain charge	$Q_{gd}$			0.63	-	
Gate resistance	$R_g$	f = 1 MHz	0.6	2.8	5.6	Ω
Turn-on delay time	t <sub>d(on)</sub>		-	11	22	ns
Rise time	t <sub>r</sub>	$V_{DD} = 10 \text{ V}, R_L = 1 \Omega$		25	50	
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong 5$ A, $V_{GEN} = 4.5$ V, $R_g = 1~\Omega$	-	16	35	
Fall time	t <sub>f</sub>		-	7	15	
Turn-on delay time	t <sub>d(on)</sub>		-	6	15	
Rise time	t <sub>r</sub>	$V_{DD} = 10 \text{ V}, R_L = 1 \Omega$	-	5	10	
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong 5 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	15	30	
Fall time	t <sub>f</sub>		-	5	10	
<b>Drain-Source Body Diode Characteristic</b>	s					
Continuous source-drain diode current I <sub>S</sub> Pulse diode forward current I <sub>SM</sub>		T <sub>C</sub> = 25 °C	-	-	4.5	۸
				=	30	A
Body diode voltage V <sub>SD</sub>		I <sub>S</sub> = 5 A, V <sub>GS</sub> = 0 V	-	0.82	1.2	V
Body diode reverse recovery time	t <sub>rr</sub>		-	9	20	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	$I_F = 5 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	2	5	nC
Reverse recovery fall time	t <sub>a</sub>	T <sub>J</sub> = 25 °C	-	4.8	-	ns
Reverse recovery rise time	t <sub>b</sub>		-	4.1	-	

#### Notes

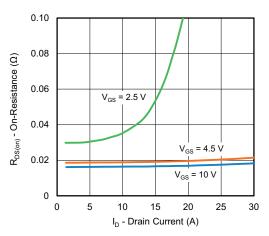
- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

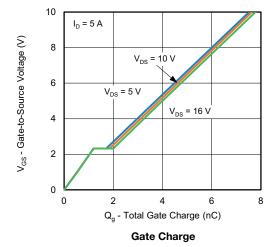


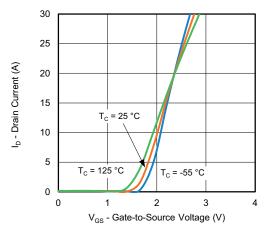


#### **Output Characteristics**

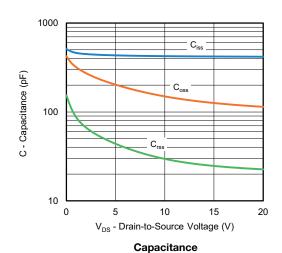


On-Resistance vs. Drain Current and Gate Voltage





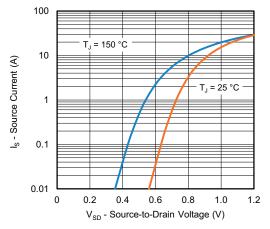
**Transfer Characteristics** 



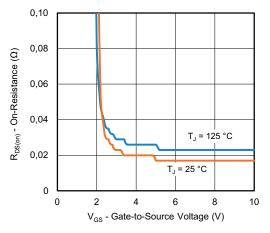
1.5 I<sub>D</sub> = 5 A R<sub>DS(on)</sub> - On-Resistance (Normalized) 1.4  $V_{GS} = 4.5 \text{ V}$ 1.3 1.2 1.1  $V_{GS} = 2.5 \text{ V}$ 1.0 0.9 8.0 0.7 -25 125 150 -50 0 50 75 100 T<sub>J</sub> - Junction Temperature (°C)

**On-Resistance vs. Junction Temperature** 

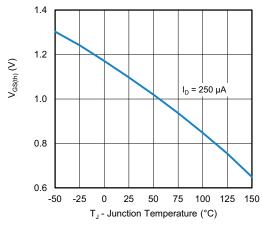




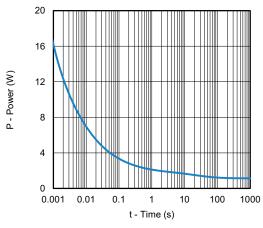
Source-Drain Diode Forward Voltage



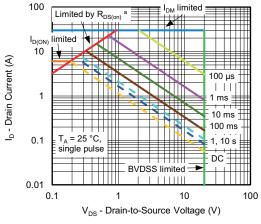
On-Resistance vs. Gate-to-Source Voltage



**Threshold Voltage** 



Single Pulse Power (Junction-to-Ambient)

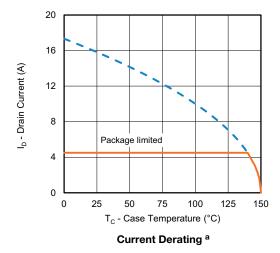


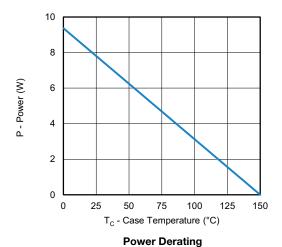
Safe Operating Area, Junction-to-Ambient

#### Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified



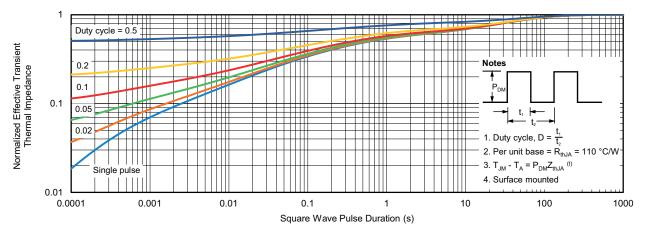




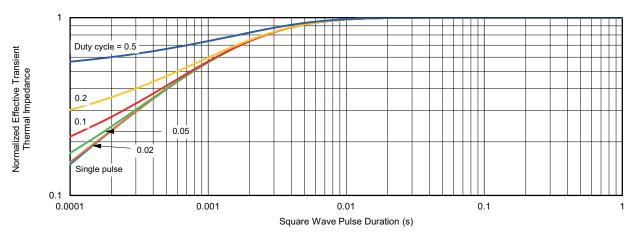
#### Note

a. The power dissipation  $P_D$  is based on  $T_J$  max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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Vishay Siliconix

# PowerPAK® SC70-6L





BACKSIDE VIEW OF SINGLE

BACKSIDE VIEW OF DUAL



- All dimensions are in millimeters
   Package outline exclusive of mold flash and metal burr
   Package outline inclusive of plating

			SINGL	E PAD			DUAL PAD						
DIM	M	ILLIMETER	RS		INCHES		M	ILLIMETER	RS		INCHES		
	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max	
Α	0.675	0.75	0.80	0.027	0.030	0.032	0.675	0.75	0.80	0.027	0.030	0.032	
A1	0	-	0.05	0	-	0.002	0	-	0.05	0	-	0.002	
b	0.23	0.30	0.38	0.009	0.012	0.015	0.23	0.30	0.38	0.009	0.012	0.015	
С	0.15	0.20	0.25	0.006	0.008	0.010	0.15	0.20	0.25	0.006	0.008	0.010	
D	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085	
D1	0.85	0.95	1.05	0.033	0.037	0.041	0.513	0.613	0.713	0.020	0.024	0.028	
D2	0.135	0.235	0.335	0.005	0.009	0.013							
Е	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085	
E1	1.40	1.50	1.60	0.055	0.059	0.063	0.85	0.95	1.05	0.033	0.037	0.041	
E2	0.345	0.395	0.445	0.014	0.016	0.018							
E3	0.425	0.475	0.525	0.017	0.019	0.021							
е		0.65 BSC			0.026 BSC	,	0.65 BSC			0.026 BSC			
K		0.275 TYP	1		0.011 TYP		0.275 TYP			0.011 TYP			
K1		0.400 TYP	1		0.016 TYP			0.320 TYP			0.013 TYP		
K2		0.240 TYP	1		0.009 TYP			0.252 TYP			0.010 TYP		
К3		0.225 TYP	1	0.009 TYP									
K4		0.355 TYP	1		0.014 TYP								
L	0.175	0.275	0.375	0.007	0.011	0.015	0.175	0.275	0.375	0.007	0.011	0.015	
Т							0.05	0.10	0.15	0.002	0.004	0.006	
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# RECOMMENDED PAD LAYOUT FOR PowerPAK® SC70-6L Single



Dimensions in mm/(Inches)

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ATTLICATION NOT



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